

FORM PTO-1594 (Modified) (Rev. 6-93) OMB No. 0651-0011 (exp. 4/94) Copyright 1994-97 LegalStar TM05/REV03

02-13-2003



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Docket No.:

5687-001

Tab settings

To the Honorable Commissioner of Patents

102364500

See the attached original documents or copy thereof.

1. Name of conveying party(ies):

Viasystems Group, Inc.

- Individual(s), Association, General Partnership, Limited Partnership, Corporation-State Delaware, Other

Additional names(s) of conveying party(ies) Yes No

3. Nature of conveyance:

- Assignment, Merger, Security Agreement, Change of Name, Other

Execution Date: February 6, 2003

2. Name and address of receiving party(ies):

Name: Viasystems Technologies Corp., L.L.C. d/b/a

Internal Address: Viasystems TC, L.L.C.

Street Address: 101 S. Hanley, Suite 400

City: St. Louis State: MO ZIP: 63105

- Individual(s) citizenship, Association, General Partnership, Limited Partnership, Corporation-State, Other Limited Liability Company - Delaware

If assignee is not domiciled in the United States, a domestic designation is Designations must be a separate document from Additional name(s) & address(es)

4. Application number(s) or registration numbers(s):

A. Trademark Application No.(s)

2/7/03

B. Trademark Registration No.(s)

2,255,502 2,235,931

Additional numbers Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Casper Scott Yost, Esq.

Internal Address: Herzog, Crebs & McGhee, LLP

Street Address: One City Centre, 24th Floor

515 North 6th Street

City: St. Louis State: MO ZIP: 63101

6. Total number of applications and registrations involved:

2

7. Total fee (37 CFR 3.41): \$ 880.00

- Enclosed, Authorized to be charged to deposit account

8. Deposit account number:

03-0942

02/12/2003 ECDOPER 00000236 030942 2255502

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Casper Scott Yost Name of Person Signing

CASPER SCOTT YOST, ESQ. Signature

02/06/03 Date

Total number of pages including cover sheet, attachments, and



**ASSIGNMENT**


WHEREAS, Viasystems Group, Inc. of 101 S. Hanley, Suite 400, St. Louis, Missouri 63105 (hereinafter "Assignor"), has adopted and is the owner of the entire right, title and interest in the trademarks referenced on Exhibit A, a copy of which is attached and incorporated herein by reference (collectively, the "Marks"), together with the goodwill of the business associated therewith.

WHEREAS, Viasystems Technologies Corp., L.L.C. dba Viasystems TC, L.L.C., a limited liability company duly organized under the laws of the State of Delaware (hereinafter "Assignee"), having its principal office and place of business at 101 S. Hanley, Suite 400, St. Louis, Missouri 63105, is desirous of acquiring all rights, title and interest in the Marks and the goodwill of the business associated therewith.

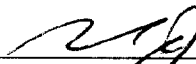
NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, BE IT KNOWN THAT, for and in consideration of valuable consideration to it paid by Assignee, the receipt and sufficiency of which is hereby acknowledged, Assignor by these presents does hereby assign, sell, transfer and set over to said Assignee, Assignor's entire right, title and interest in the Marks, together with the goodwill of the business associated therewith, including the right to sue for past and present infringement, the same to be held and enjoyed by Assignee for its own use and for the use of its successors and assigns, as fully and entirely as the same would have been held and enjoyed by Assignor if this assignment and sale had not been made.

Signed at St. Louis, Missouri as of FEBRUARY 6, 2003.

"Assignor"  
VIASYSTEMS GROUP, INC.

Name:   
Printed Name: David J. Webster  
Title: Senior Vice President

"Assignee"  
VIASYSTEMS TECHNOLOGIES CORP., L.L.C.  
dba VIASYSTEMS TC, L.L.C.

Name:   
Printed Name: David J. Webster  
Title: Senior Vice President

**Exhibit A**

**Trademarks Registered in the United States of America**

Registration No.	Registration Date	Mark	International Class	Description of Goods/Services
2,255,502	June 22, 1999	Viasolutions	40 and 42	<b>IC 40:</b> Custom manufacture of motherboards, backplane systems, and other printed electric circuit boards. <b>IC 42:</b> Custom design of motherboards, backplane systems and other printed electric circuit boards.
2,235,931	March 30, 1999	Viasystems (and Design)	40 and 42	<b>IC 40:</b> Custom manufacture of motherboards, backplane systems, and other printed electric circuit boards. <b>IC 42:</b> Custom design of motherboards, backplane systems and other printed electric circuit boards.